



## **N-Channel Enhancement-Mode** Vertical DMOS FET

#### Features

- Low threshold
- High input impedance
- Low input capacitance (110pF max.)
- Fast switching speeds
- Low on-resistance
- Free from secondary breakdown
- Low input and output leakage

### Applications

- Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives ►
- Analog switches
- General purpose line drivers
- Telecom switches

### Ordering Information

Part Number	Package Option	Packing		
TN2501N8-G	TO-243AA (SOT-89)	2000/Reel		

-G denotes a lead (Pb)-free / RoHS compliant package.

Contact factory for Wafer / Die availablity.

Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

## Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV <sub>DSS</sub>
Drain-to-gate voltage	BV <sub>DGS</sub>
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## **Typical Thermal Resistance**

Package	$oldsymbol{ heta}_{ja}$
TO-243AA (SOT-89)	133°C/W

### **General Description**

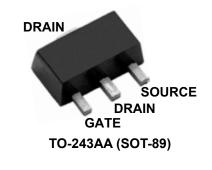
This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

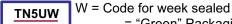
### Product Summarv

$\mathbf{BV}_{\mathrm{DSS}}/\mathbf{BV}_{\mathrm{DGS}}$	R <sub>DS(ON)</sub> (max)	l <sub>D(ON)</sub> (min)	V <sub>GS(TH)</sub> (max)
18V	2.5Ω	250mA	1.0V

## **Pin Configuration**



### **Product Marking**



= "Green" Packaging

Package may or may not include the following marks: Si or 👘 TO-243AA (SOT-89)

## TN2501

### **Thermal Characteristics**

Package	l <sub>D</sub> (continuous) <sup>†</sup>	Ι <sub>D</sub> (pulsed)	Power Dissipation @T <sub>c</sub> = 25°C	I <sub>DR</sub> <sup>†</sup>	DRM	
TO-243AA (SOT-89)	400mA	560mA	1.6W <sup>‡</sup>	400mA	560mA	

Notes:

*†*  $I_D$  (continuous) is limited by max rated  $T_i$ .

 $\ddagger$  T<sub>A</sub> = 25°C. Mounted on FR5 Board, 25mm x 25mm x 1.57mm.

#### Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise specified)

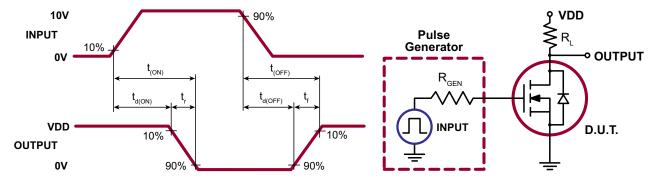
Sym	Parameter	Min	Тур	Max	Units	Conditions		
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	18	-	-	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 1.0mA		
V <sub>GS(th)</sub>			-	1.0	V	$V_{GS} = V_{DS}, I_{D} = 1.0 \text{mA}$		
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with temperature	-	-	-4.0	mV/ºC	$V_{GS} = V_{DS}, I_{D} = 1.0 \text{mA}$		
I <sub>GSS</sub>	Gate body leakage	-	-	100	nA	$V_{GS} = \pm 15V, V_{DS} = 0V$		
		-	-	10	μA	$V_{GS}$ = 0V, $V_{DS}$ = Max Rating		
I <sub>DSS</sub>	Zero gate voltage drain current		-	1.0	mA	$V_{DS} = 0.8Max$ Rating, $V_{GS} = 0V$ , $T_A = 125^{\circ}C$		
I <sub>D(ON)</sub>	On-state drain current		600	-	А	$V_{GS} = V_{DS} = 3.0V$		
	Static drain-to-source on-state resistance	-	-	25	Ω	V <sub>GS</sub> = 1.2V, I <sub>D</sub> = 3.0mA		
R <sub>DS(ON)</sub>		-	-	3.5		V <sub>GS</sub> = 2.0V, I <sub>D</sub> = 50mA		
			-	2.5		V <sub>GS</sub> = 3.0V, I <sub>D</sub> = 200mA		
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature		-	0.75	%/°C	V <sub>GS</sub> = 3.0V, I <sub>D</sub> = 200mA		
G <sub>FS</sub>	Forward transductance	150	300	-	mmho	V <sub>DS</sub> = 3.0V, I <sub>D</sub> = 200mA		
C <sub>ISS</sub>	Input capacitance	-	-	110		V <sub>GS</sub> = 0V,		
C <sub>oss</sub>	Common source output capacitance	-	-	60	pF	V <sub>DS</sub> = 15V,		
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	35		f = 1.0MHz		
t <sub>d(ON)</sub>	Turn-on delay time	-	-	5.0				
t <sub>r</sub>	Rise time	-	-	15	20	$V_{DD} = 15V,$ L = 250mA		
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	15	ns	$I_{D} = 250 \text{mA},$ $R_{GEN} = 25\Omega$		
t <sub>r</sub>	Fall time	-	-	8.0				
V <sub>SD</sub>	Diode forward voltage drop	-	1.1	1.8	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 200mA		
t <sub>rr</sub>	Reverse recovery time	-	100	-	ns	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 200mA		

Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)

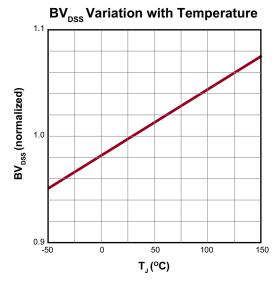
2. All A.C. parameters sample tested.

### Switching Waveforms and Test Circuit

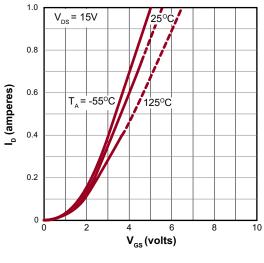


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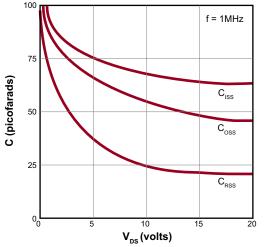
### **Typical Performance Curves**

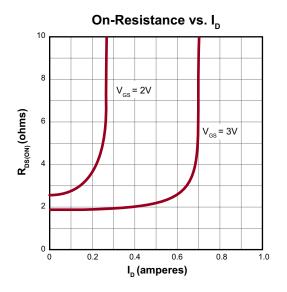




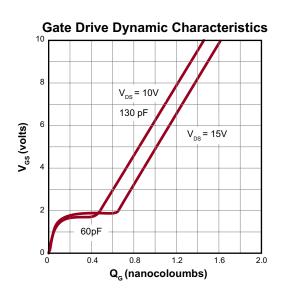


Capacitance vs. Drain-to-Source Voltage



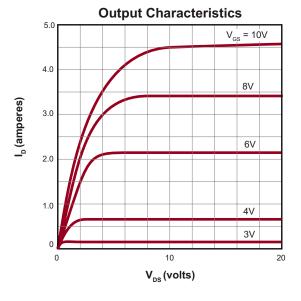


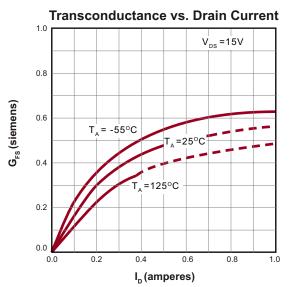
 $V_{(th)}$  and  $R_{DS}$  Variation with Temperature 1.6 1.4 R<sub>DS(ON)</sub>@ 3V, 0.2A 1.4 1.2 V<sub>GS(th)</sub> (normalized) R<sub>Ds(ON)</sub> (normalized) V<sub>(th)</sub>@ 1mA 1.2 1.0 1.0 0.8 0.8 0.6 **\_\_\_** <sub>0.6</sub> 150 0 50 100 -50 T\_(°C)



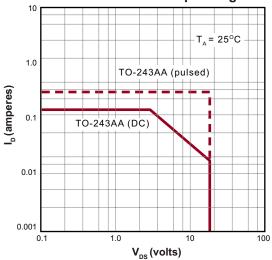
## TN2501

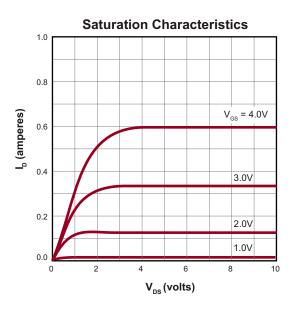
### Typical Performance Curves (cont.)



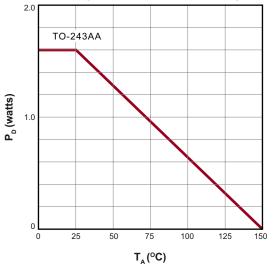


Maximum Rated Safe Operating Area

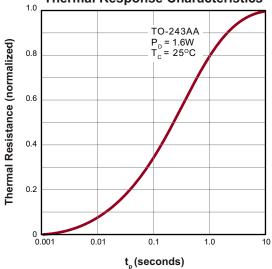




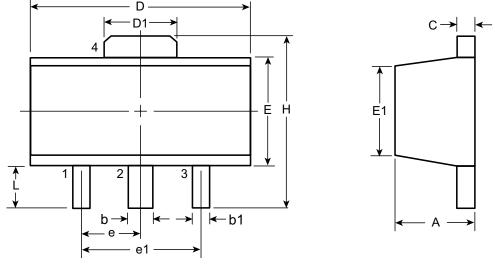
**Power Dissipation vs. Ambient Temperature** 



Thermal Response Characteristics



# 3-Lead TO-243AA (SOT-89) Package Outline (N8)



Top View

Side View

Symbo	ol	Α	b	b1	С	D	D1	Е	E1	е	e1	Н	L
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00†	1.50 BSC		3.94	0.73†
	NOM	-	-	-	-	-	-	-	-		3.00 BSC	-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29		200	200	4.25

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

*†* This dimension differs from the JEDEC drawing

Drawings not to scale.

Supertex Doc. #: DSPD-3TO243AAN8, Version F111010.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.supertex.com/packaging.html</u>.)

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